TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

TC7SA05F,TC7SA05FU

Inverter (Open Drain)

Features

• Low voltage operation: V_{CC} = 1.8~3.6 V

• High speed operation : t_{pz} = 3.5 ns (max) (V_{CC} = 3.0~3.6 V)

: t_{pz} = 4.1 ns (max) (V_{CC} = 2.3~2.7 V)

: t_{pz} = 8.2 ns (max) (V_{CC} = 1.8 V)

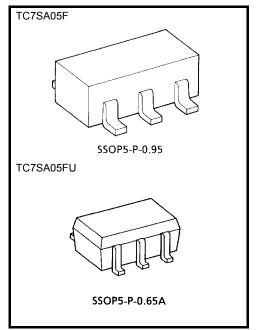
• High Output current : I_{OL} = 24 mA (min) (V_{CC} = 3.0 V)

 $: I_{OL} = 18 \text{ mA (min)} (V_{CC} = 2.3 \text{ V})$

 $: I_{OL} = 6 \text{ mA (min) (V}_{CC} = 1.8 \text{ V)}$

• 3.6-V tolerant input.

• 3.6-V power down protection output.



Weight

SSOP5-P-0.95 : 0.016 g (typ.) SSOP5-P-0.65A : 0.006 g (typ.)

Absolute Maximum Ratings (Ta = 25°C)

Characteristics	Symbol	Rating	Unit
Power supply voltage	V _{CC}	-0.5~4.6	V
DC input voltage	V _{IN}	-0.5~4.6	V
DC output voltage	V _{OUT}	−0.5~4.6 (Note 1)	V
Input diode current	I _{IK}	-50	mA
Output diode current	lok	−50 (Note 2)	mA
DC output current	lout	±50	mA
Power dissipation	PD	200	mW
DC V _{CC} /ground current	Icc	±100	mA
Storage temperature range	T _{stg}	-65~150	°C

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

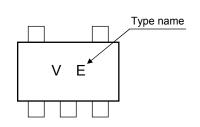
Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: IOUT absolute maximum rating must be observed.

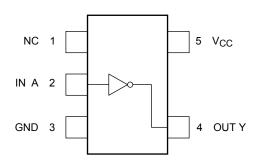
Note 2: VOUT < GND

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Marking



Pin Assignment (top view)



Logic Diagram



Truth Table

А	Y
L	Z
Н	L

Z: High impedance

Operating Ranges

Characteristics	Symbol	Rating	Unit
Dower aupply voltage	Vaa	1.8~3.6	V
Power supply voltage	V _{CC}	1.2~3.6 (Note 3)	V
Input voltage	V _{IN}	-0.3~3.6	V
Output voltage	V _{OUT}	0~V _{CC}	V
		24 (Note 4)	
Output current	I _{OH} /I _{OL}	18 (Note 5)	mA
		6 (Note 6)	
Operating temperature range	T _{opr}	-40~85	°C
Input rise and fall time	dt/dv	0~10 (Note 7)	ns/V

Note 3: Data retention only

Note 4: $V_{CC} = 3.0 \sim 3.6 \text{ V}$

Note 5: $V_{CC} = 2.3 \sim 2.7 \text{ V}$

Note 6: $V_{CC} = 1.8 \text{ V}$

Note 7: $V_{IN} = 0.8 \sim 2.0 \text{ V}, V_{CC} = 3.0 \text{ V}$



Electrical Characteristics

DC Characteristics (Ta = -40~85°C, 2.7 V < V_{CC} \leq 3.6 V)

Characteristics		Symbol	Tes	et Condition	V _{CC} (V)	Min	Max	Unit
land to all and	High level	V _{IH}		_	2.7~3.6	2.0	_	
Input voltage	Low level	V _{IL}		_	2.7~3.6	_	0.8	V
		V _{OL} V _{IN} = V _{IH}		I _{OL} = 100 μA	2.7~3.6	_	0.2	
Output voltage Low level	Lowlovel		$V_{IN} = V_{IH}$	I _{OL} = 12 mA	2.7	_	0.4	V
	Low level			I _{OL} = 18 mA	3.0	_	0.4	
					I _{OL} = 24 mA	3.0	_	0.55
Input leakage curre	ent	I _{IN}	V _{IN} = 0~3.6 V		2.7~3.6	_	±5.0	μА
Power off leakage	ver off leakage current I _{OFF}		V _{IN} , V _{OUT} = 0~3.6 V		0		10.0	μА
Quiescent supply current		I _{CC}	V _{IN} = V _{CC} or GND		2.7~3.6	_	20.0	
			$V_{CC} \le (V_{IN}, V_{OUT}) \le 3.6 \text{ V}$		2.7~3.6		±20.0	μΑ
Increase in I _{CC} per	input	Δl _{CC}	$V_{IH} = V_{CC} - 0.$	6 V	2.7~3.6	_	750	

DC Characteristics (Ta = $-40~85^{\circ}$ C, 2.3 V \leq V_{CC} \leq 2.7 V)

Characteristics		Symbol Test Cond		condition		Min	Max	Unit							
Charac	teristics	Symbol			V _{CC} (V)	IVIIII	IVIAX	Offic							
Input voltage	High level	V _{IH}	-	_	2.3~2.7	1.6	_	V							
input voltage	Low level	V _{IL}	_		2.3~2.7	_	0.7	V							
				$I_{OL} = 100 \mu A$	2.3~2.7	_	0.2								
Output voltage	Low level	V _{OL}	V_{OL}	V_{OL}	V _{OL}	V_{OL}	V_{OL}	V_{OL}	V_{OL}	$V_{IN} = V_{IH}$	I _{OL} = 12 mA	2.3	_	0.4	V
				I _{OL} = 18 mA	2.3	_	0.6								
Input leakage curre	ent	I _{IN}	V _{IN} = 0~3.6 V		2.3~2.7	_	±5.0	μΑ							
Power off leakage	current	l _{OFF}	V _{IN} , V _{OUT} = 0~3.6 V		V _{IN} , V _{OUT} = 0~3.6 V		0	_	10.0	μΑ					
Quiescent supply current I _{CC}			V _{IN} = V _{CC} or GND		2.3~2.7	_	20.0	^							
		V _{CC} ≤ (V _{IN} , V _{OUT}	-) ≦ 3.6 V	2.3~2.7	_	±20.0	μА								

DC Characteristics (Ta = $-40\sim85^{\circ}$ C, 1.8 V \leq V_{CC} < 2.3 V)

Charac	cteristics	Symbol	Test Condition		V _{CC} (V)	Min	Max	Unit	
Input voltage	High level	V _{IH}	_		1.8~2.3	0.7 × V _{CC}	_	V	
input voltage	Low level	V _{IL} —		_	1.8~2.3	_	0.2 × V _{CC}	V	
Output voltage	Low level	V	\/-·	V _{IN} = V _{IH}	$I_{OL} = 100 \mu A$	1.8	_	0.2	V
Output voitage	Low level	V _{OL}	VIN = VIH	I _{OL} = 6 mA	1.8	_	0.3	\ \ \	
Input leakage curre	ent	I _{IN}	V _{IN} = 0~3.6 V		1.8	_	±5.0	μА	
Power off leakage	current	l _{OFF}	V _{IN} , V _{OUT} = 0~3.6 V		0	_	10.0	μА	
Quiescent supply current I _{CC}		loo	V _{IN} = V _{CC} or GND		1.8	_	20.0	^	
		$V_{CC} \le (V_{IN}, V_{OUT}) \le 3.6 \text{ V}$		1.8	_	±20.0	μΑ		

AC Characteristics (Ta = -40~85°C, input: $t_r = t_f = 2.0$ ns, $C_L = 30$ pF, $R_L = 500$ Ω)

Characteristics	Symbol	Test Condition	V _{CC} (V)	Min	Max	Unit
	t _{pZL}		1.8	1.0	8.2	ns
		t _{pZL} Figure 1, Figure 2	2.5 ± 0.2	8.0	4.1	
Propagation delay time			3.3 ± 0.3	0.6	3.5	
Propagation delay time	t _{pLZ}	Figure 1, Figure 2	1.8	1.0	6.8	
			2.5 ± 0.2	0.8	3.8	ns
			3.3 ± 0.3	0.6	3.5	

For $C_L = 50\ pF$, add approximately 300 ps to the AC maximum specification.

Capacitive Characteristics (Ta = 25°C)

Characteristics	Symbol	Toot Condition		Tun	Unit	
Characteristics	Syllibol	Test Condition		V _{CC} (V)	Тур.	Ullit
Input capacitance	C _{IN}	_		1.8, 2.5, 3.3	4	pF
Output capacitance	C _{OUT}	_			3	pF
Power dissipation capacitance	C _{PD}	f _{IN} = 10 MHz	(Note 8)	1.8, 2.5, 3.3	4	pF

Note 8: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation.

 $I_{CC (opr.)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}$

AC Test Circuit

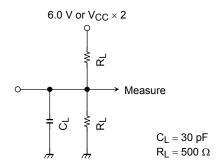
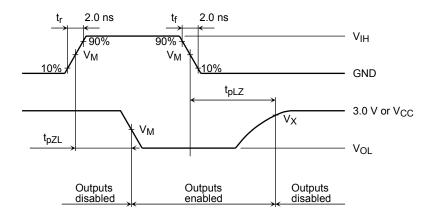


Figure 1

AC Waveforms



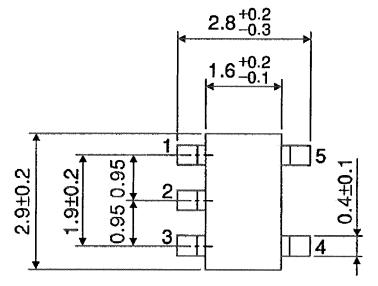
Symbol	Vcc							
Symbol	$3.3\pm0.3~\textrm{V}$	$2.5\pm0.2~\textrm{V}$	1.8 V					
V _{IH}	2.7 V	V _{CC}	V _{CC}					
V _M	1.5 V	V _{CC} /2	V _{CC} /2					
VX	V _{OH} – 0.3 V	V _{OH} – 0.15 V	V _{OH} – 0.15 V					

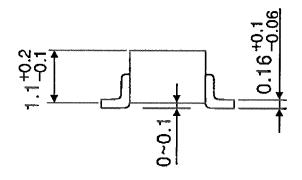
Figure 2 t_{pZL}, t_{pLZ}

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Package Dimensions

SSOP5-P-0.95 Unit: mm



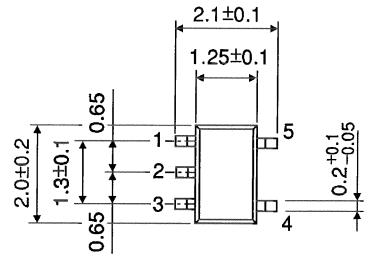


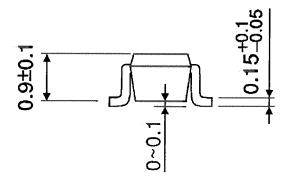
Weight: 0.016 g (typ.)

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Package Dimensions

SSOP5-P-0.65A Unit: mm





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Weight: 0.006 g (typ.)

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